



Product Summary

| Ī | V _{(BR)DSS} | R _{DS(ON)} | Ι _D T _A = +25°C |
|---|----------------------|-------------------------------|--|
| | 20V | 0.12Ω @ V _{GS} = 10V | 2.2A |

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Motor Control

20V N-CHANNEL ENHANCEMENT MODE MOSFET

Features

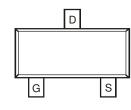
- Low On-Resistance
- Fast Switching Speed
- Low Threshold
- Low Gate Drive
- Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

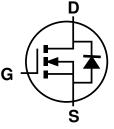
- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208e3
- Lead-free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)



Top View



Top View Pin Configuration



Equivalent Circuit

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|-------|--------------------|
| ZXMN2A01FTA | SOT23 | 3,000/Tape & Reel |
| ZXMN2A01FTC | SOT23 | 10,000/Tape & Reel |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

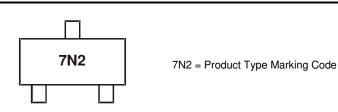
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

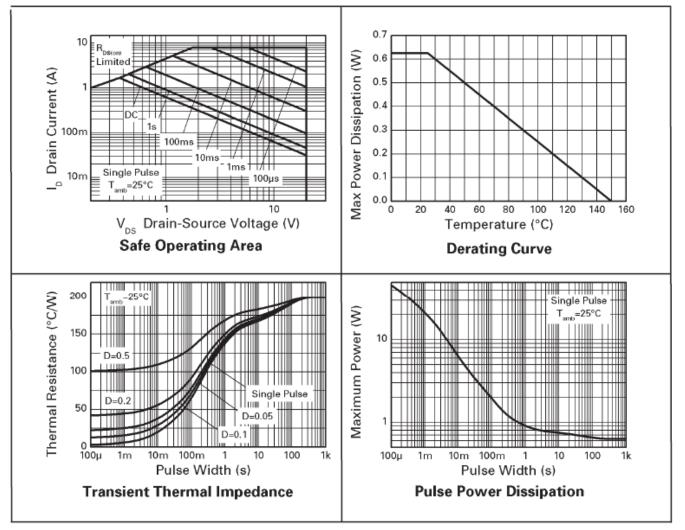
| Characteristi | Symbol | Value | Units | | |
|---|----------------------------------|--|----------------|-------------------|---|
| Drain-Source Voltage | V _{DSS} | 20 | V | | |
| Gate-Source Voltage | V _{GSS} | ±12 | V | | |
| Continuous Drain Current, V _{GS} = 10V | (Note 6) (Note 6) (Note 5) | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ $T_A = +25^{\circ}C$ | Ι _D | 2.2 1.7 1.9 | А |
| Pulsed Drain Current (Note 7) | I _{DM} | 8 | A | | |
| Maximum Body Diode Continuous Current (Note | ls | 1.29 | A | | |
| Maximum Body Diode Continuous Current (Note | I _{SM} | 8 | A | | |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Units |
|---|------------------------------|-----------------------------------|-------------|-------|
| Total Power Dissipation | (Note 5) | PD | 625 | mW |
| Linear Derating Factor | (11010-0) | ' D | 5 | mW/°C |
| Total Power Dissipation | I Power Dissipation (Note 6) | | 806 | mW |
| Linear Derating Factor | (Note 0) | PD | 6.4 | mW/°C |
| Thermal Resistance, Junction to Ambient | (Note 5) | P | 200 | °C/W |
| mermai Resistance, Junction to Ambient | (Note 6) | R _{0JA} | 155 | |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C |

Notes: 5. For a device surface mounted on 25mm x 25mm FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions. 6. For a device surface mounted on FR-4 PCB measured at t≤5 secs.

7. Repetitive rating 25mm x 25mm FR4 PCB, D = 0.05, pulse width 10µs - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.



ZXMN2A01F Document number: DS33513 Rev. 4 - 2



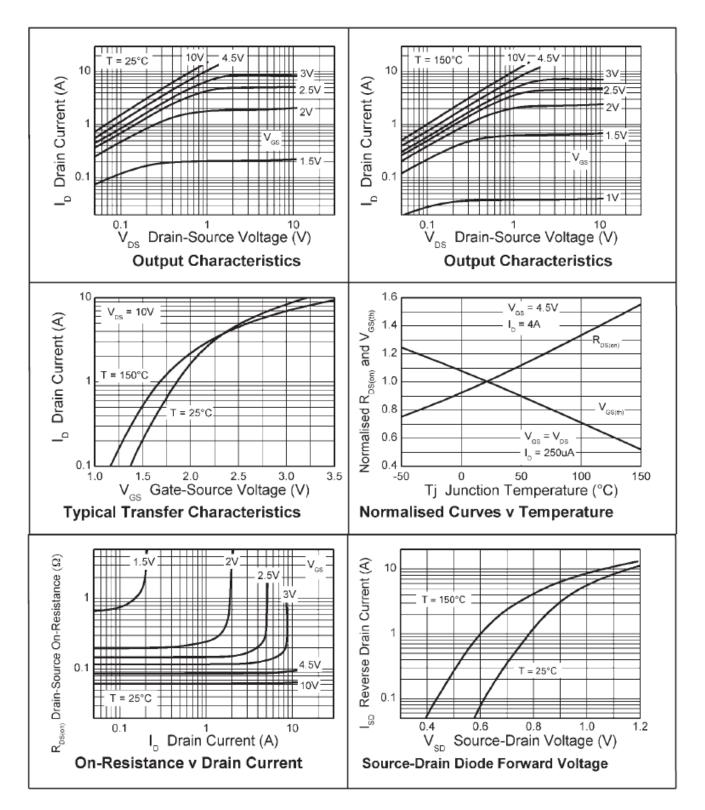
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|------|-------|------|--|--|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 20 | | _ | V | $V_{GS} = 0V, I_D = 250 \mu A$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | | 1 | μΑ | $V_{DS} = 20V, V_{GS} = 0V$ | |
| Gate-Body Leakage | IGSS | _ | _ | 100 | nA | $V_{GS} = \pm 12V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS | | | | | | · | |
| Gate Threshold Voltage | V _{GS(th)} | 0.7 | | _ | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | |
| Static Drain-Source On-Resistance (Note 8) | | _ | _ | 0.12 | Ω | $V_{GS} = 4.5V, I_D = 4A$ | |
| Static Drain-Source On-Hesistance (Note 8) | R _{DS(ON)} | | | 0.225 | Ω | $V_{GS} = 2.5V, I_D = 1.5A$ | |
| Forward Transconductance | g fs | | 6.1 | _ | S | $V_{DS} = 10V, I_D = 4A$ | |
| Diode Forward Voltage (Note 8 & 10) | V _{SD} | | 0.85 | 0.95 | V | $V_{GS} = 0V, I_S = 3.2A, T_J = +25^{\circ}C$ | |
| DYNAMIC CHARACTERISTICS (Note 10) | | | | | | | |
| Input Capacitance | Ciss | | 303 | _ | | | |
| Output Capacitance | Coss | | 59 | — | pF | $V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz | |
| Reverse Transfer Capacitance | C _{rss} | | 30 | _ | | | |
| Total Gate Charge (Note 9) | Qg | | 3.0 | — | | | |
| Gate-Source Charge (Note 9) | Q _{gs} | _ | 0.8 | _ | nC | $V_{DS} = 10V, V_{GS} = 10V,$ $I_{D} = 4A$ | |
| Gate-Drain Charge (Note 9) | Q _{gd} | _ | 1.0 | _ | | $I_D = 4A$ | |
| Turn-On Delay Time (Note 9) | t _{D(on)} | _ | 2.49 | _ | | | |
| Turn-On Rise Time (Note 9) | tr | | 5.21 | _ | ns | | |
| Turn-Off Delay Time (Note 9) | t _{D(off)} | | 7.47 | | 115 | | |
| Turn-Off Fall Time (Note 9) | t _f | | 4.62 | | | | |
| Reverse Recovery Time | t _{rr} | | 23 | — | ns | | |
| Reverse Recovery Charge | Qrr | | 5.65 | | nC | $T_J = +25^{\circ}C, I_F = 4A, di/dt = 100A/\mu s$ | |

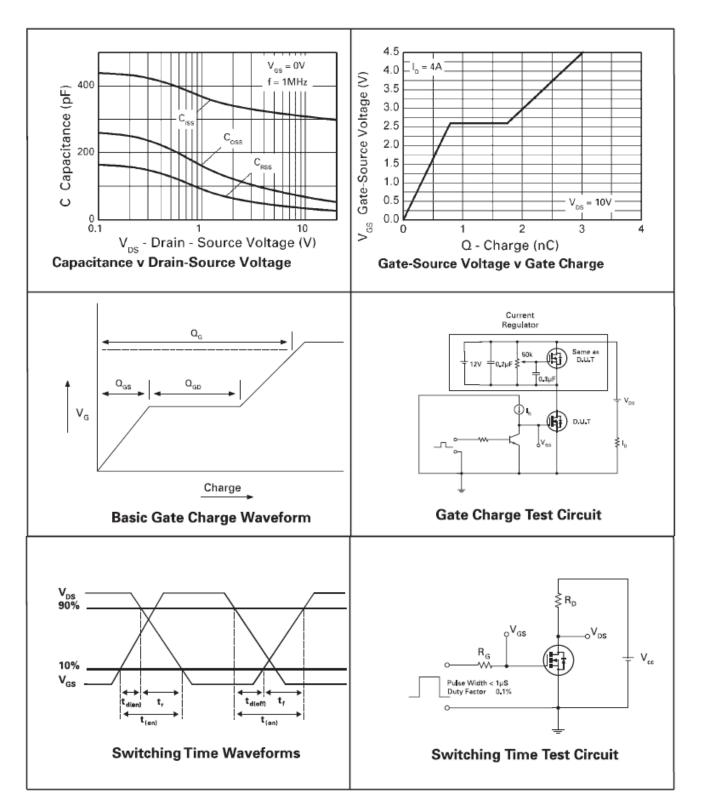
Notes:

8. Measured under pulsed conditions. Width=300µs. Duty cycle ≤ 2%.
9. Switching characteristics are independent of operating junction temperature.
10. Guaranteed by design. Not subject to production testing.





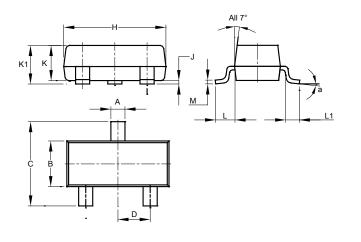






Package Outline Dimensions

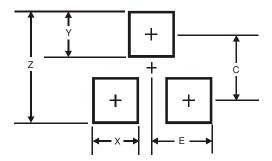
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SOT23 | | | | | | |
|----------------------|-------------|-------|-------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 0.37 | 0.51 | 0.40 | | | |
| В | 1.20 | 1.40 | 1.30 | | | |
| С | 2.30 | 2.50 | 2.40 | | | |
| D | 0.89 | 1.03 | 0.915 | | | |
| F | 0.45 | 0.60 | 0.535 | | | |
| G | 1.78 | 2.05 | 1.83 | | | |
| Н | 2.80 | 3.00 | 2.90 | | | |
| J | 0.013 | 0.10 | 0.05 | | | |
| К | 0.890 | 1.00 | 0.975 | | | |
| K1 | 0.903 | 1.10 | 1.025 | | | |
| L | 0.45 | 0.61 | 0.55 | | | |
| L1 | 0.25 | 0.55 | 0.40 | | | |
| М | 0.085 | 0.150 | 0.110 | | | |
| а | a 8° | | | | | |
| All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.9 |
| Х | 0.8 |
| Y | 0.9 |
| С | 2.0 |
| E | 1.35 |



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